



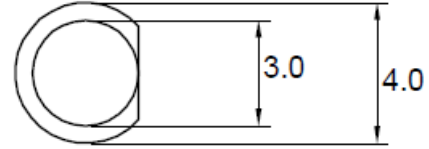
# American Opto Plus LED Corp.

## L317GYW

### 3mm Yellow and Green Bi-color LED Lamp

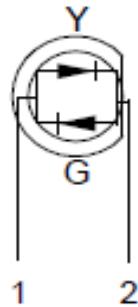
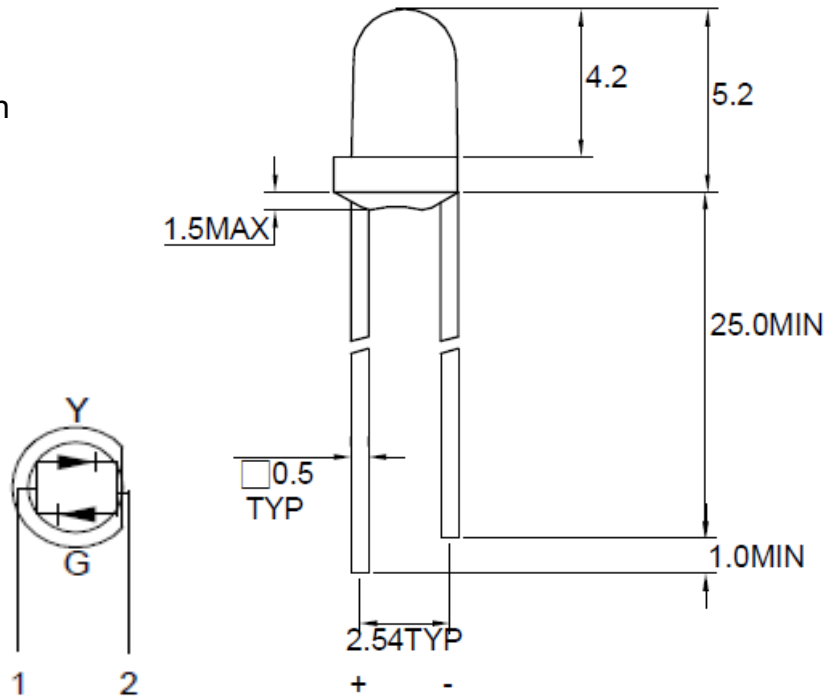
#### DESCRIPTION

- Round Type
- 3mm Diameter
- Lens Color: White Diffused
- With Flange
- Solder leads without standoffs



#### FEATURES

- Emitted Color: Yellow and Green
- Technology: GaAsP/GaP
- Viewing Angle: 70°



#### NOTES:

1. All dimensions are in millimeters tolerance is  $\pm 0.25$ mm unless otherwise noted;

Part Number	Material	Lens Color	
		Emitted	Lens
L317GYW	GaAsP/GaP	Yellow	White Diffused
	GaP	Green	



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### ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Ratings		Unit
		Y	G	
Forward Current	I <sub>F</sub>	20	30	mA
Peak Forward Current Duty 1/10 @ 10KHz	I <sub>FP</sub>	80	120	mA
Reverse Voltage	V <sub>R</sub>	5	5	V
Power Dissipation	P <sub>d</sub>	60	100	mW
Operating temperature range	Topr	-40~+85		°C
Storage temperature range	Tstg	-40~+100		°C

### OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	--	--	10	μA
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	Y 1.7	--	2.6	V
			G 1.7	--	2.6	
Luminous Intensity	I <sub>V</sub>		Y 8	12	--	mcd
			G 3	5	--	
Peak Wavelength	λ <sub>P</sub>		Y --	585	--	nm
			G --	565	--	
Spectral Halfwidth	Δλ		Y --	35	--	nm
			G --	30	--	
Viewing Angle	2θ ½		Y --	70	--	deg
			G --	70	--	

Note:

1. The forward voltage data did not include ±0.1V testing tolerance.
2. The luminous intensity data did not include ±15% testing tolerance.



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## TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVE (YELLOW)

Fig.1 Forward current vs. Forward Voltage

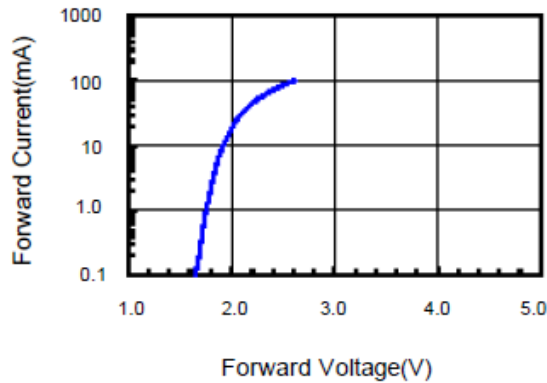


Fig.2 Relative Intensity vs. Forward Current

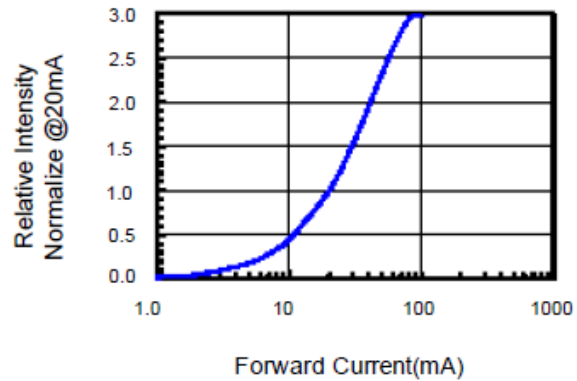


Fig.3 Forward Voltage vs. Temperature

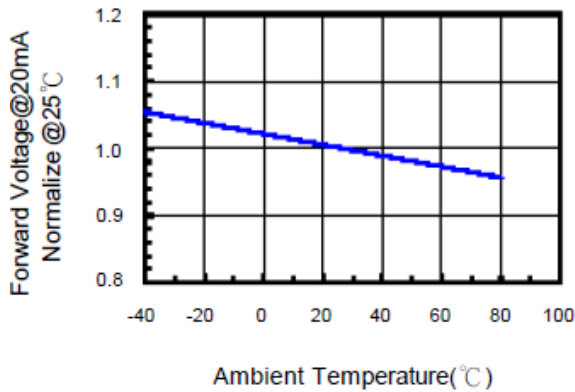


Fig.4 Relative Intensity vs. Temperature

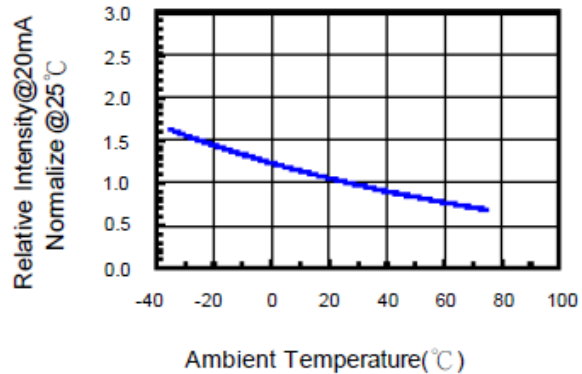
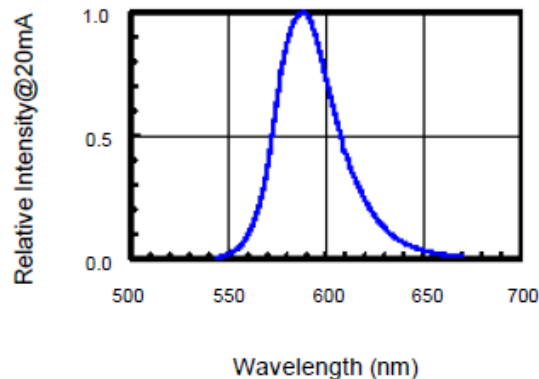


Fig.5 Relative Intensity vs. Wavelength





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## L317GYW

3mm Yellow and Green Bi-color LED Lamp

### TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVE (GREEN)

Fig.1 Forward current vs. Forward Voltage

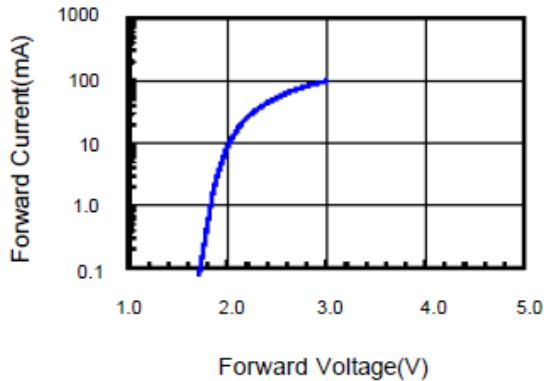


Fig.2 Relative Intensity vs. Forward Current

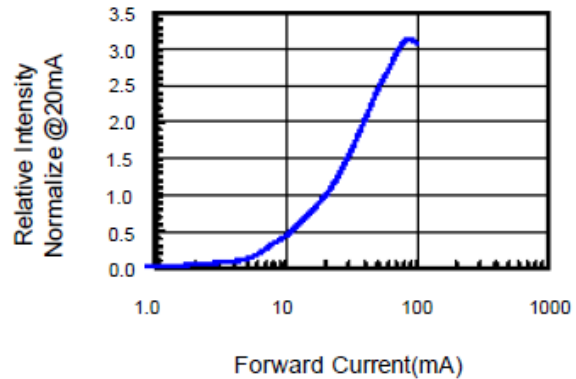


Fig.3 Forward Voltage vs. Temperature

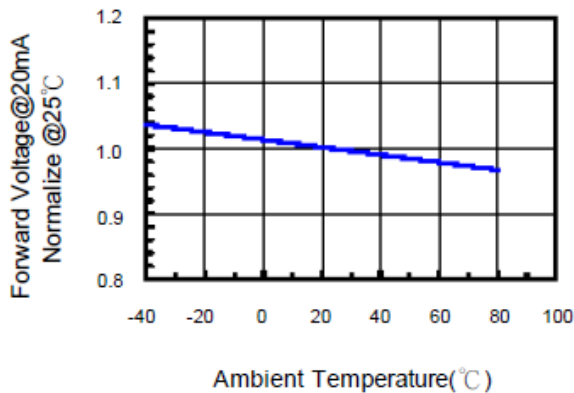


Fig.4 Relative Intensity vs. Temperature

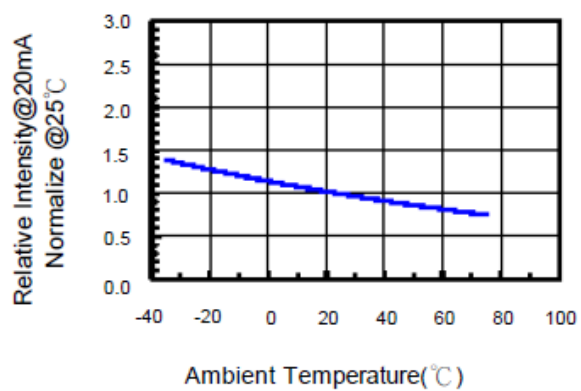
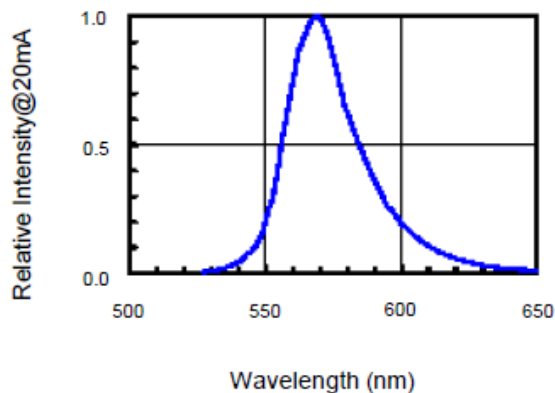


Fig.5 Relative Intensity vs. Wavelength





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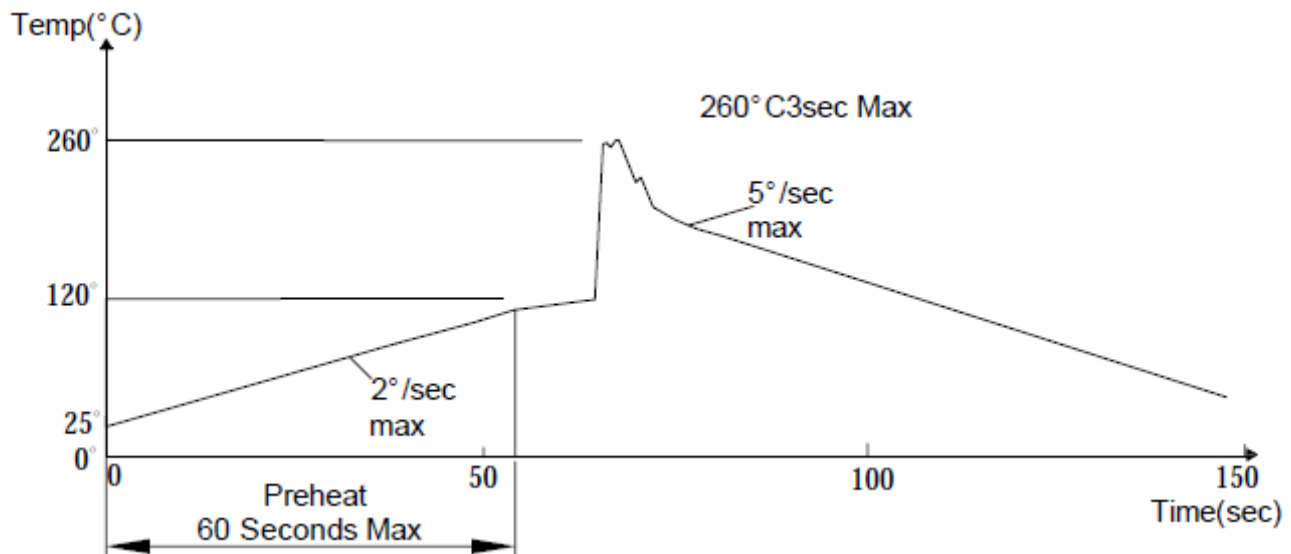
### SOLDERING CONDITION (Pb-Free)

#### 1. Iron:

Soldering Iron: 30W Max  
Temperature 350° C Max  
Soldering Time: 3 Seconds Max (One time only)  
Distance: 2mm Min (From solder joint to body)

#### 2. Wave Soldering Profile

Dip Soldering  
Preheat: 120° C Max  
Preheat time: 60 seconds Max  
Ramp-up  
2° C/sec (max)  
Ramp-Down: -5° C/sec (max)  
Solder Bath: 260° C Max  
Dipping Time: 3 seconds Max  
Distance: 2mm Min (From solder joint to body)



#### Note:

1. Wave solder should not be made more than one time.
2. You can just only select one of the soldering conditions as above.



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#### RELIABILITY TEST

Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65 °C±5°C 2.RH=90 %~95 % 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 °C±5°C & -40 °C±5°C (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011
Solder Resistance Test	1.T.Sol=260 °C±5°C 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 °C±5°C 2.Dwell time=5±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2